TE Internal #: 2379397-5

Internal I/O Connectors, Mini Cool Edge I/O (MCIO), Cable Plug Assembly, Vertical, Cable-to-Board, SFF-TA-1016, 74 Position,

Surface Mount

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Connectors > PCB Connectors > Internal I/O Connectors











Internal I/O Connector Type: Mini Cool Edge I/O (MCIO)

Connector Mates With: Cable Plug Assembly

PCB Mount Orientation: Vertical
Connector System: Cable-to-Board
Industry Standard: SFF-TA-1016

Features

Product Type Features

Internal I/O Connector Type	Mini Cool Edge I/O (MCIO)
Connector Mates With	Cable Plug Assembly
Connector System	Cable-to-Board
Connector & Contact Terminates To	Printed Circuit Board

Configuration Features

Number of Rows	2
PCB Mount Orientation	Vertical
Number of Positions	74

Contact Features

Contact Mating Area Plating Material	Gold
Contact Underplating Material	Nickel
PCB Contact Termination Area Plating Material	Tin
Contact Base Material	Copper Alloy
Contact Current Rating (Max)	1 A



Contact Mating Area Plating Material Thickness	.076 μm[30 μin]

Termination Features

Termination Method to Printed Circuit Board	Surface Mount	

Mechanical Attachment

Connector Mounting Type	Board Mount	

Housing Features

Centerline (Pitch) .6 mm[.023 in]

Usage Conditions

Operating Temperature Range	-55 – 85 °C[-67 – 185 °F]

Operation/Application

Circuit Application	Signal

Industry Standards

Industry Standard	SFF-TA-1016	

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Reflow solder capable to 260°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides



on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts









Customers Also Bought





SLIVER 2.0















Documents

Product Drawings
MCIO INTERGRATED CONN, V/T,8X, SMT TYPE

English



CAD Files

Customer View Model

ENG_CVM_CVM_2379397-5_A.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_2379397-5_A.3d_stp.zip

English

Customer View Model

ENG_CVM_CVM_2379397-5_A.3d_igs.zip

English

3D PDF

3D

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Product Specifications

Application Specification

English

Product Environmental Compliance

Product Compliance

English

Product Compliance

English